# Application Data Sheet

# **Application Information**

Application number::

Filing Date::

Application Type::

Subject Matter::

Title ::

Small Entity?::

Attorney Docket Number::

Total Drawing Sheets::

Regular

Utility

SEMICONDUCTOR DEVICE

AND FABRICATING

**METHOD THEREOF** 

0756-7217

10 No

# Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan Akira

Given Name:: Middle Name::

Family Name::

ISHIKAWA

Name Suffix::

City of Residence::

State or Province of Residence::

Country of Residence::

Street of mailing address::

Atsugi

Kanagawa

Japan

c/o Semiconductor Energy

Laboratory Co., Ltd.

398, Hase

City of mailing address:: Atsugi-shi State or Province of mailing address:: Kanagawa-ken Country of mailing address:: Japan Postal or Zip Code of mailing address:: 243-0036 Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan Given Name:: Shingo Middle Name:: Family Name:: **EGUCHI** Name Suffix:: City of Residence:: Tochigi State or Province of Residence:: Tochigi Country of Residence:: Japan Street of mailing address:: c/o Semiconductor Energy Laboratory Co., Ltd. 398, Hase City of mailing address:: Atsugi-shi State or Province of mailing address:: Kanagawa-ken Country of mailing address:: Japan Postal or Zip Code of mailing address:: 243-0036 Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan Given Name:: Seiji Middle Name::

Family Name::

City of Residence::

Name Suffix::

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ODA -

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City of mailing address:: Osaki-shi

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Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 545-0013

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Given Name:: Yoshinori

Middle Name::

Family Name:: HIGAMI

Name Suffix::

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#### Correspondence Information

Correspondence Customer Number ::

31780

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### Representative Information

Representative Customer Number::

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#### **Domestic Priority Information**

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

## Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-320785	11/05/2002	Yes

### **Assignee Information**

Assignee name::

Semiconductor Energy

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398 Hase

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Country of mailing address:: Japan

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